



11-24-98

To the Assistant Commissioner for Patents: Please

100921104

(s) or copy(ies) thereof.

1. Name of conveying party(ies):

Makoto ISHIMARU

Additional name(s) of conveying party(ies) attached? No

2. Name and address of receiving party(ies):

Name: Oki Electric Industry Co., Ltd.

Street Address: 7-12, Toranomom 1-chome,
Minato-ku, Tokyo, Japan

Additional name(s) & address(es) attached? No

11/24/98
09/198525
PTO
U.S.

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other

Execution Date: October 8, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: October 8, 1998

A. Patent Application No.(s) B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.
Internal Address: Attn: Mr. Nils E. Pedersen
Street Address: 2033 K Street, N.W., Suite 800
Washington, D.C. 20006

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. § 3.41) \$ 40.00
 Enclosed [Check No. 30725]
 Authorized to be charged to deposit account

8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

12/04/98
40.00
PT:381

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Nils E. Pedersen, Reg. No. 33,145 November 24, 1998
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks
Box Assignments
Washington, D.C. 20231

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Makoto Ishimaru

Insert Name(s)
of Inventor(s)

Insert Name(s)
of Assignee(s)

Address

the undersigned hereby sell(s) and assign(s) to

Oki Electric Industry Co., Ltd.

of 7-12, Toranomom 1-chome, Minato-ku, Tokyo, Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of
Invention

SUBSTRATE POLISHING APPARATUS AND METHOD FOR

POLISHING SEMICONDUCTOR SUBSTRATE

Date of Signing
of Application

for which an application for patent in the United States has been executed by the undersigned on

October 8, 1998

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the Rule of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date October 8, 1998, Name of Inventor Makoto Ishimaru
Makoto Ishimaru
Date _____, Name of Inventor _____
Date _____, Name of Inventor _____
Date _____, Name of Inventor _____
Date _____, Name of Inventor _____
Date _____, Name of Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Kazuyuki Okawa
Witness Hiromi Fujiuchi

ACKNOWLEDGEMENT

_____ } ss

This _____ day of _____, 19_____, before me
personally came the above-named _____

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL _____
Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____
Applicant Reference Number _____ Atty Docket No. _____
Title of Invention _____
